



## Description

### JMT N And P-channel Enhancement Mode Power MOSFET

#### Features

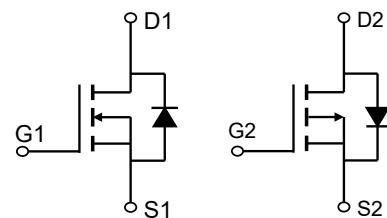
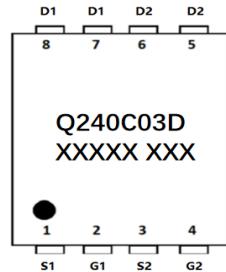
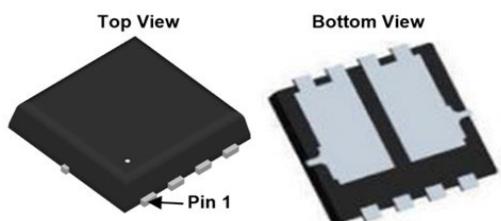
- N-channel:30V, 10A  
 $R_{DS(ON)} < 21m\Omega @ V_{GS} = 10V$   
 $R_{DS(ON)} < 30m\Omega @ V_{GS} = 4.5V$
- P-channel: -30V, -8A  
 $R_{DS(ON)} < 27m\Omega @ V_{GS} = -10V$   
 $R_{DS(ON)} < 38m\Omega @ V_{GS} = -4.5V$
- Excellent Gate Charge x  $R_{DS(ON)}$  Product(FOM)
- Very Low On-resistance  $R_{DS(ON)}$
- Fast Switching Speed

#### Applications

- Battery Protection
- Load Switch
- Power Management



100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



PDFN3x3-8L-D

Marking and Pin Assignment

Schematic Diagram

#### Package Marking and Ordering Information

Device Marking	Device	Outline	Package	Reel Size	Reel(pcs)	Per Carton (pcs)
Q240C03D	JMTQ240C03D	TAPING	PDFN3x3-8L-D	13"	5000	50000

#### Absolute Maximum Ratings (@ $T_C = 25^\circ C$ unless otherwise specified)

Symbol	Parameter		Value-N-channel	Value-P-channel	Units
$V_{DS}$	Drain-to-Source Voltage		30	-30	V
$V_{GS}$	Gate-to-Source Voltage		$\pm 20$		V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	10	-8	A
		$T_C = 100^\circ C$	6.3	-5.1	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>		40	-32	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>		12	20	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	15		W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>		66		$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		8.3		
$T_J, T_{STG}$	Junction & Storage Temperature Range		-55 to 150		$^\circ C$



JMTQ240C03D

N-channel Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.7	2.5	V
$R_{\text{DS(ON)}}$	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10\text{V}, I_D = 5\text{A}$	-	16	21	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 3\text{A}$	-	23	30	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1\text{MHz}$	-	481	-	pF
$C_{\text{oss}}$	Output Capacitance		-	69	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	53	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DD} = 15\text{V}, I_D = 3\text{A}$	-	10	-	nC
$Q_{\text{gs}}$	Gate Source Charge		-	2	-	nC
$Q_{\text{gd}}$	Gate Drain("Miller") Charge		-	2	-	nC
<b>Switching Characteristics</b>						
$t_{d(\text{on})}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DD} = 15\text{V}$ $I_D = 3\text{A}, R_{\text{GEN}} = 3\Omega$	-	4	-	ns
$t_r$	Turn-On Rise Time		-	6	-	ns
$t_{d(\text{off})}$	Turn-Off Delay Time		-	12	-	ns
$t_f$	Turn-Off Fall Time		-	3	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	10	A	
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	40	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 10\text{A}$	-	-	1.2	V
$trr$	Body Diode Reverse Recovery Time	$I_F = 3\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	8	-	ns
$Qrr$	Body Diode Reverse Recovery Charge		-	2	-	nC

P-channel Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$	-	-	-1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1	-1.7	-2.5	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = -10\text{V}, I_D = -7\text{A}$	-	21	27	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -4\text{A}$	-	29	38	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$	-	859	-	pF
$C_{\text{oss}}$	Output Capacitance		-	110	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	84	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } -10\text{V}$ $V_{DD} = -15\text{V}, I_D = -3\text{A}$	-	16	-	nC
$Q_{\text{gs}}$	Gate Source Charge		-	3	-	nC
$Q_{\text{gd}}$	Gate Drain("Miller") Charge		-	3	-	nC
<b>Switching Characteristics</b>						
$t_{d(\text{on})}$	Turn-On Delay Time	$V_{GS} = -10\text{V}, V_{DD} = -15\text{V}$ $I_D = -3\text{A}, R_{\text{GEN}} = 3\Omega$	-	4	-	ns
$t_r$	Turn-On Rise Time		-	2	-	ns
$t_{d(\text{off})}$	Turn-Off Delay Time		-	38	-	ns
$t_f$	Turn-Off Fall Time		-	22	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-8	A	
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-32	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = -8\text{A}$	-	-	-1.2	V
$trr$	Body Diode Reverse Recovery Time	$I_F = -3\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	10	-	ns
$Qrr$	Body Diode Reverse Recovery Charge		-	3	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 20\text{V}$ ,  $V_G = 10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = 7\text{A}$

Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = -20\text{V}$ ,  $V_G = -10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = -9\text{A}$

3.  $R_{\thetaJA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics-N

Figure 1: Output Characteristics

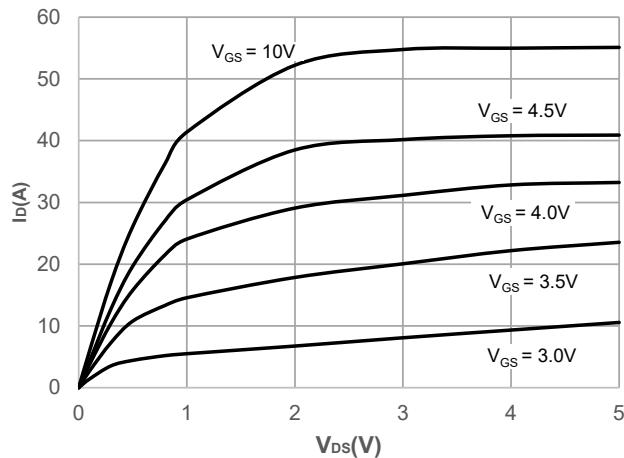


Figure 2: Typical Transfer Characteristics

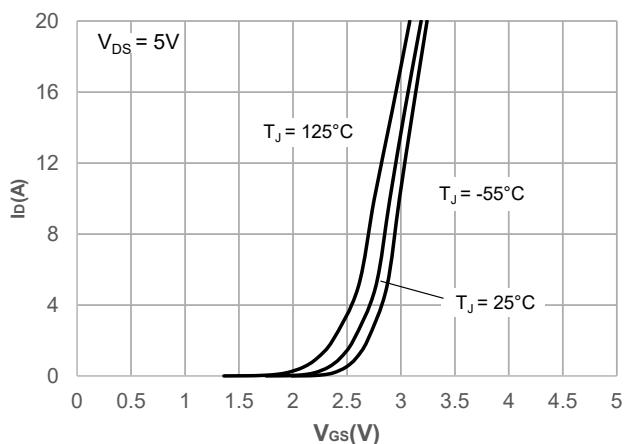


Figure 3: On-resistance vs. Drain Current

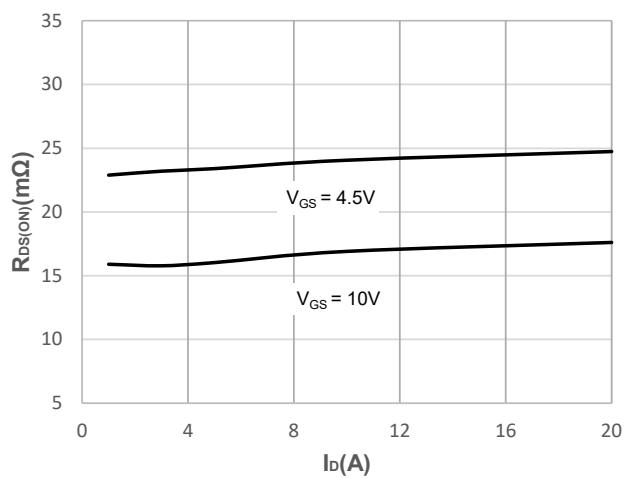


Figure 4: Body Diode Characteristics

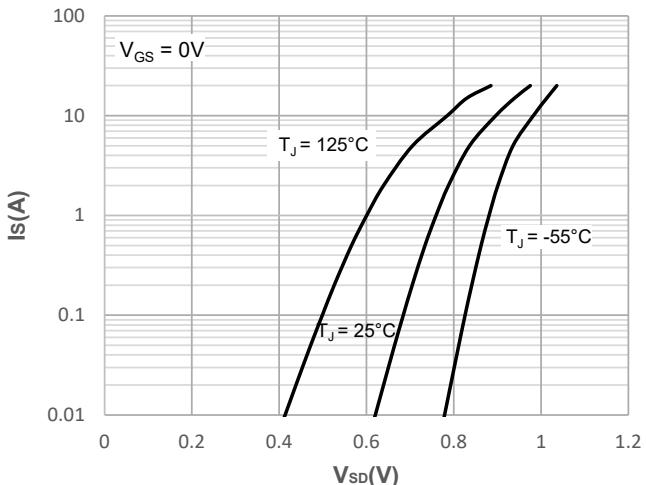


Figure 5: Gate Charge Characteristics

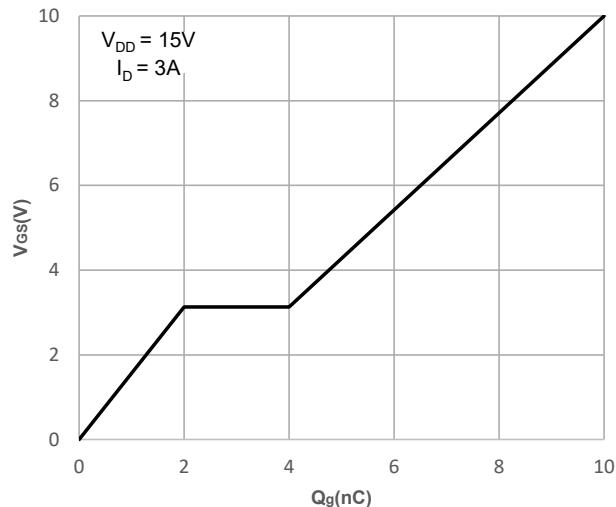
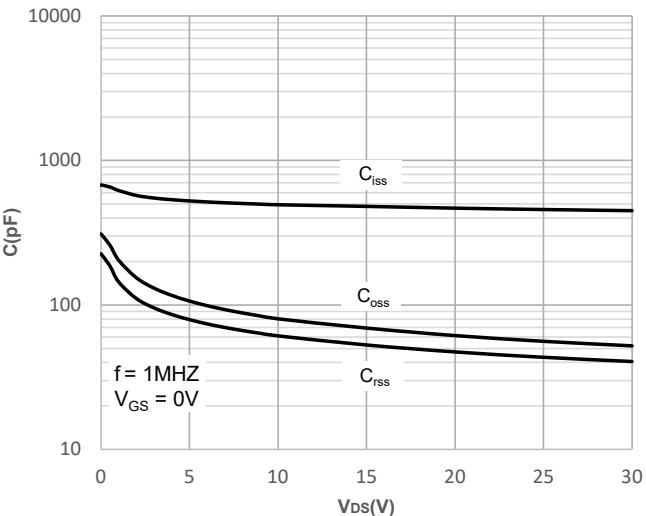
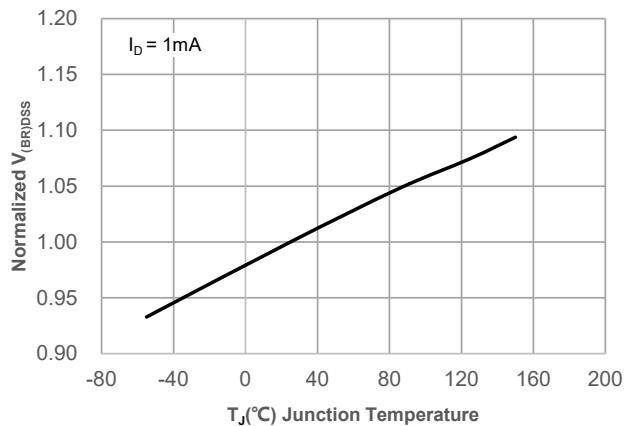


Figure 6: Capacitance Characteristics

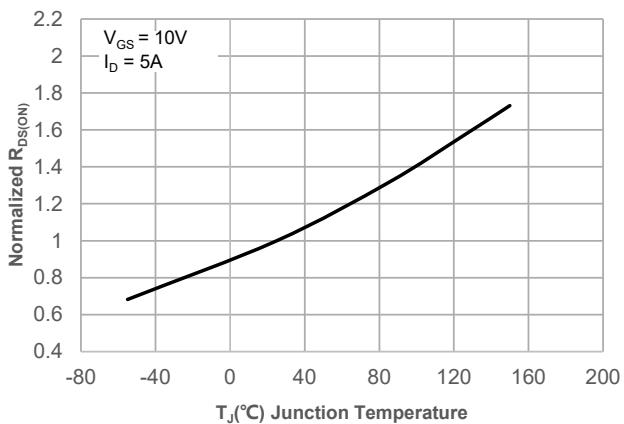


## Typical Performance Characteristics-N

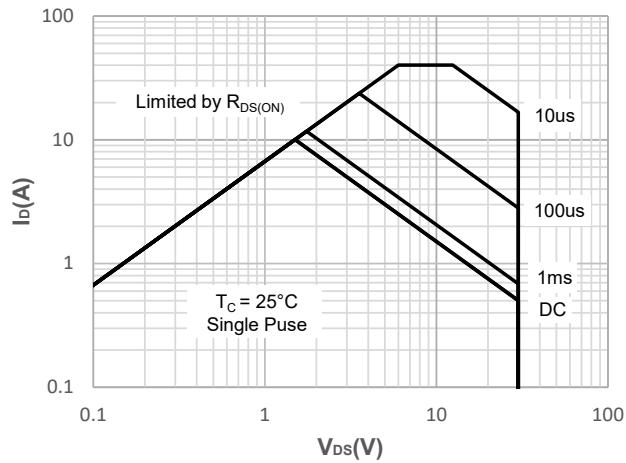
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



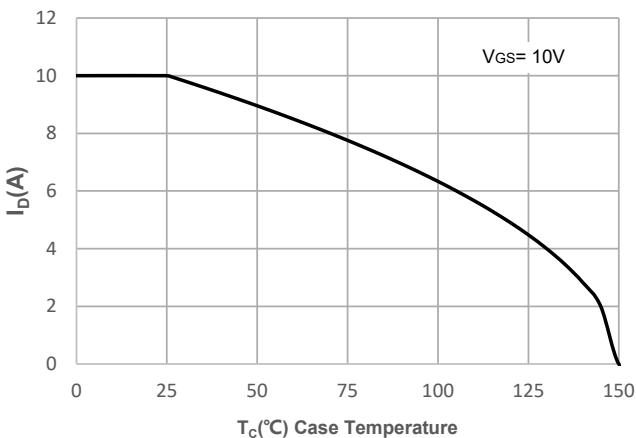
**Figure 8: Normalized on Resistance vs. Junction Temperature**



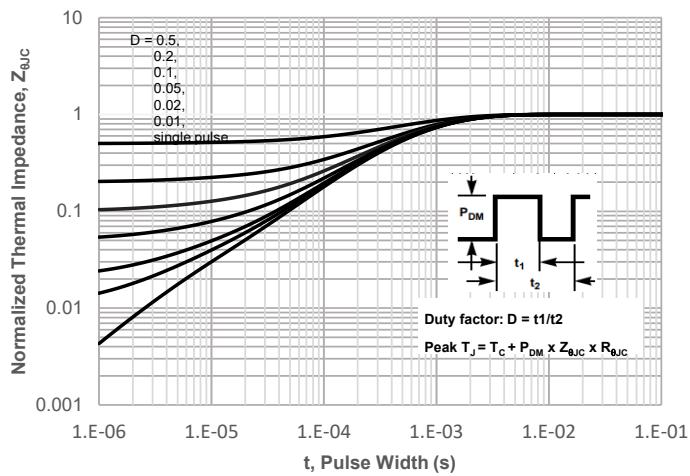
**Figure 9: Maximum Safe Operating Area**



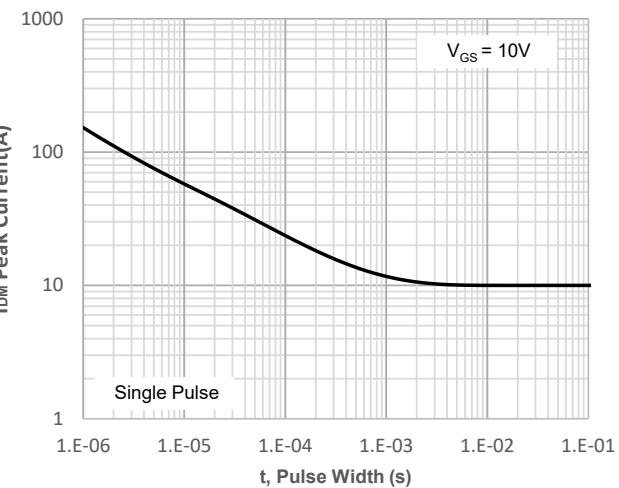
**Figure 10: Maximum Continuous Drian Current vs. Case Temperature**



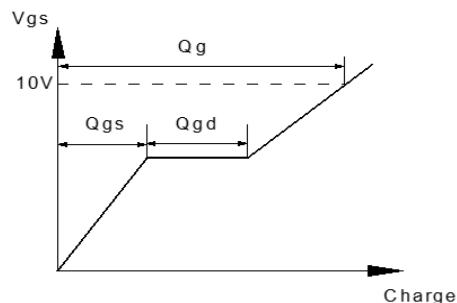
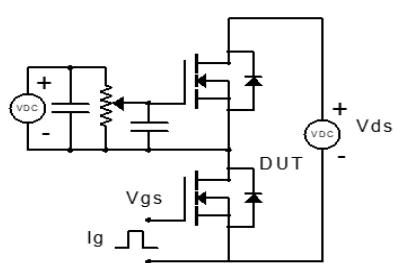
**Figure 11: Normalized Maximum Transient Thermal Impedance**



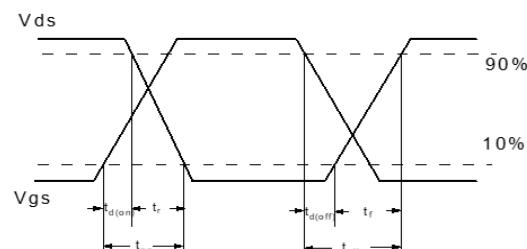
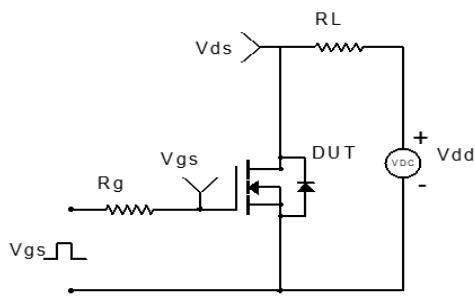
**Figure 12: Peak Current Capacity**



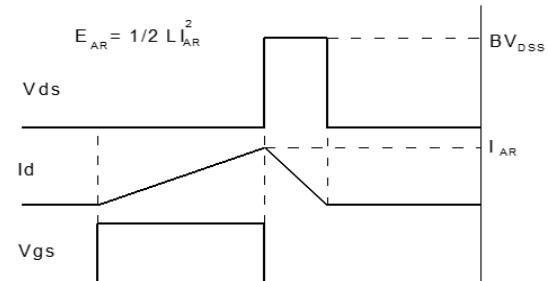
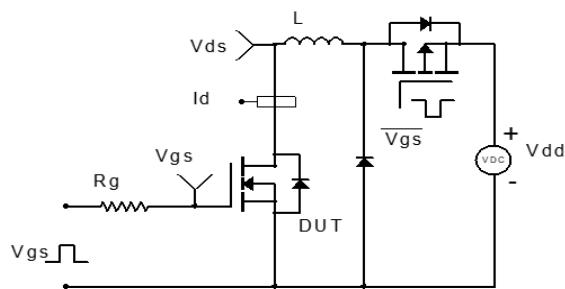
## Test Circuit-N



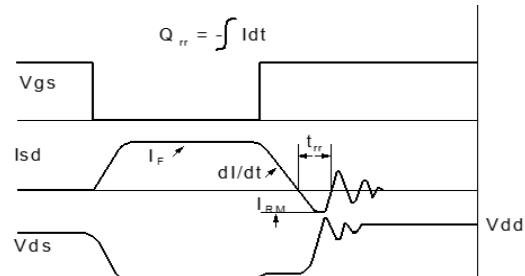
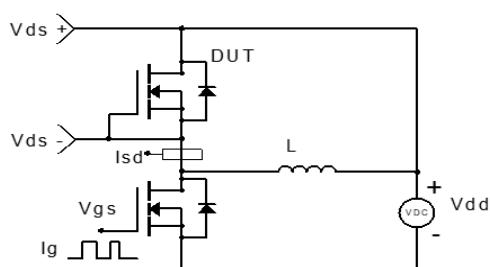
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**



**Figure 3: Unclamped Inductive Switching Test Circuit& Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Typical Performance Characteristics-P

Figure 1: Output Characteristics

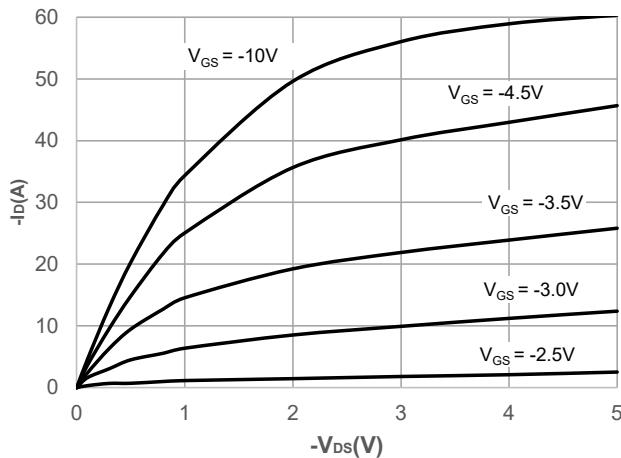


Figure 2: Typical Transfer Characteristics

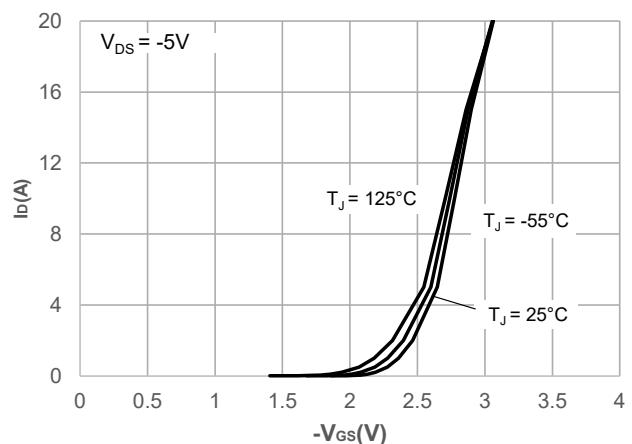


Figure 3: On-resistance vs. Drain Current

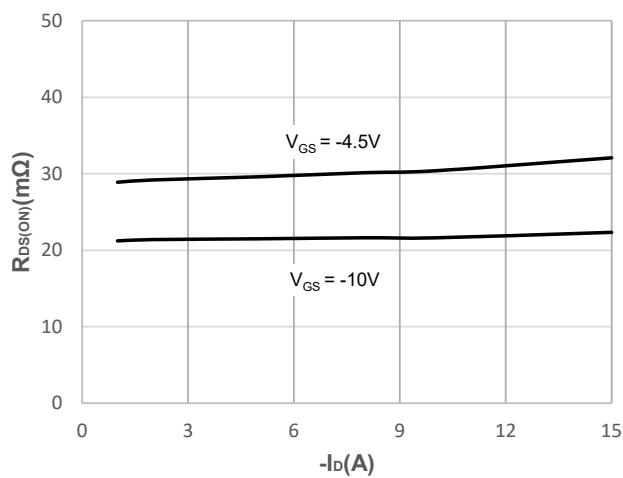


Figure 4: Body Diode Characteristics

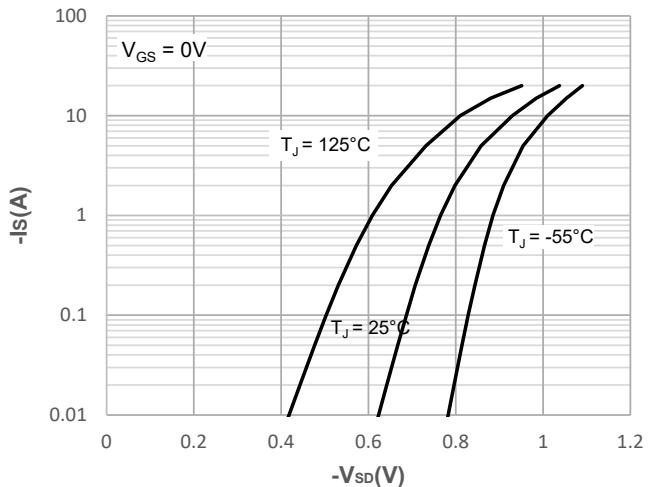


Figure 5: Gate Charge Characteristics

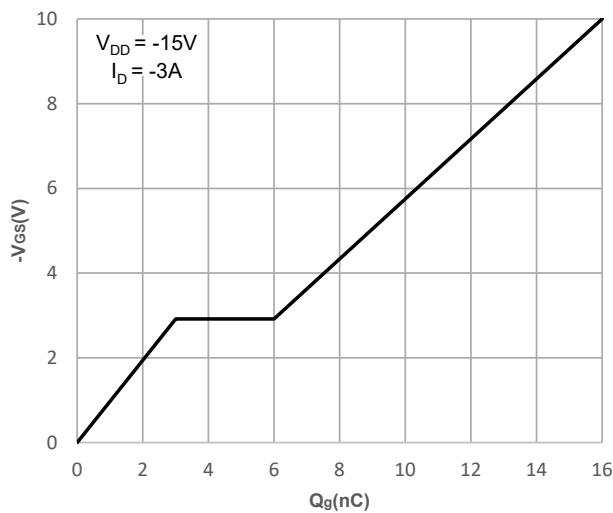
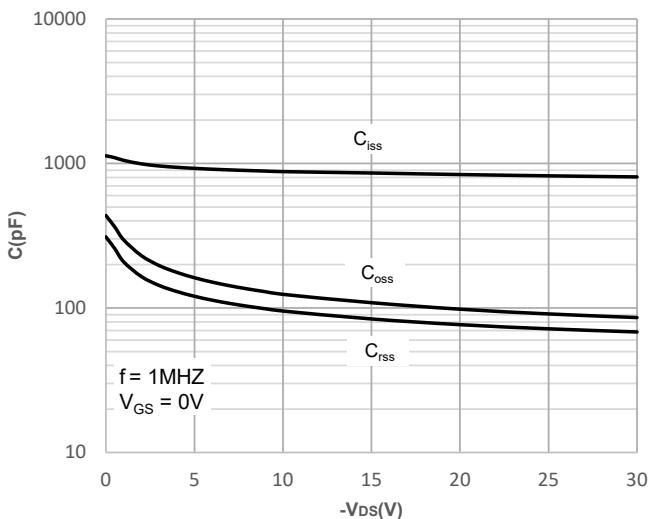
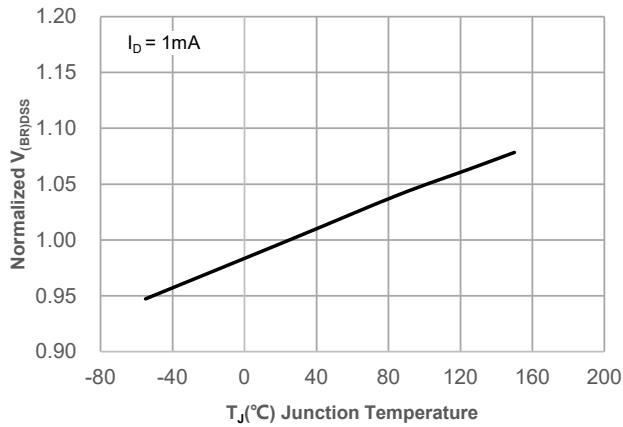


Figure 6: Capacitance Characteristics

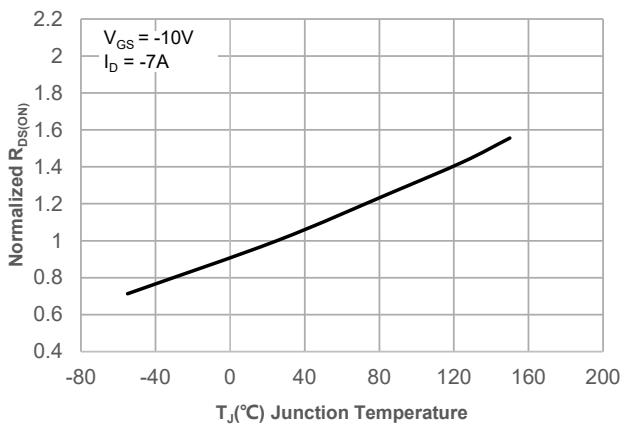


## Typical Performance Characteristics-P

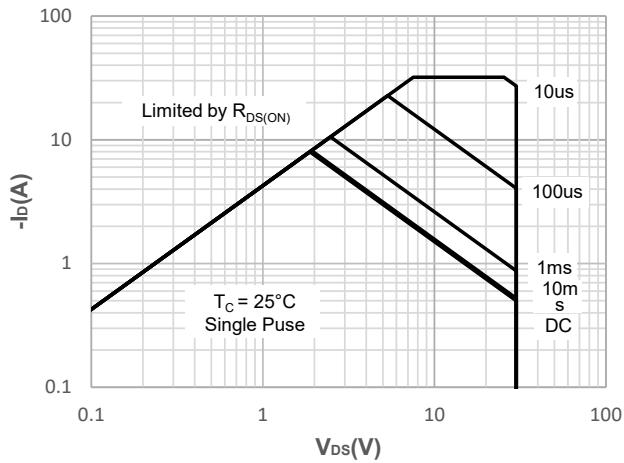
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



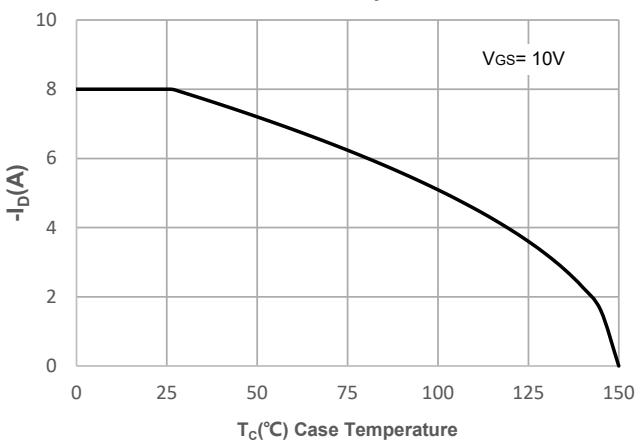
**Figure 8: Normalized on Resistance vs. Junction Temperature**



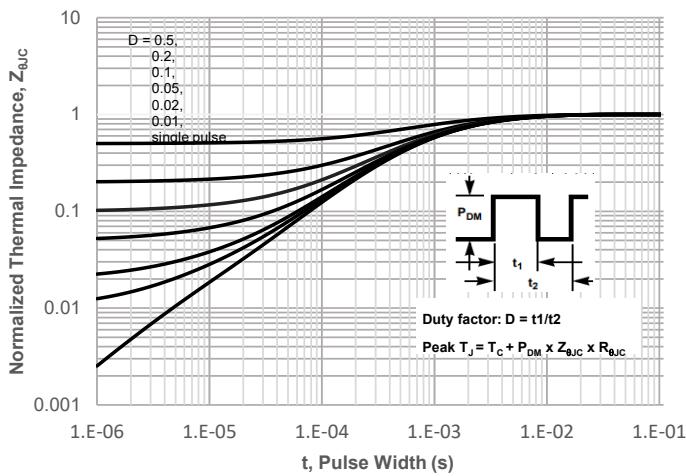
**Figure 9: Maximum Safe Operating Area**



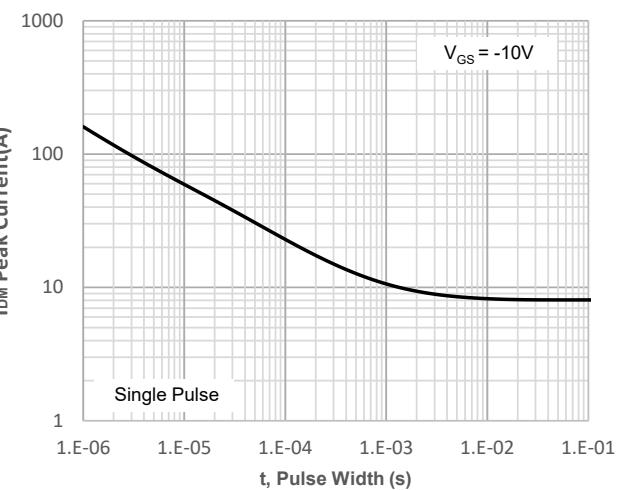
**Figure 10: Maximum Continuous Drian Current vs. Case Temperature**



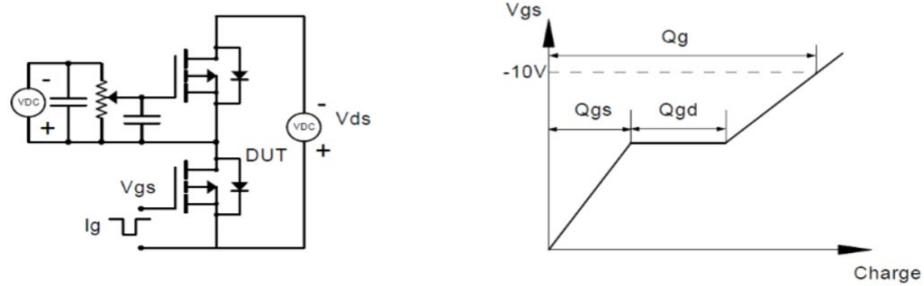
**Figure 11: Normalized Maximum Transient Thermal Impedance**



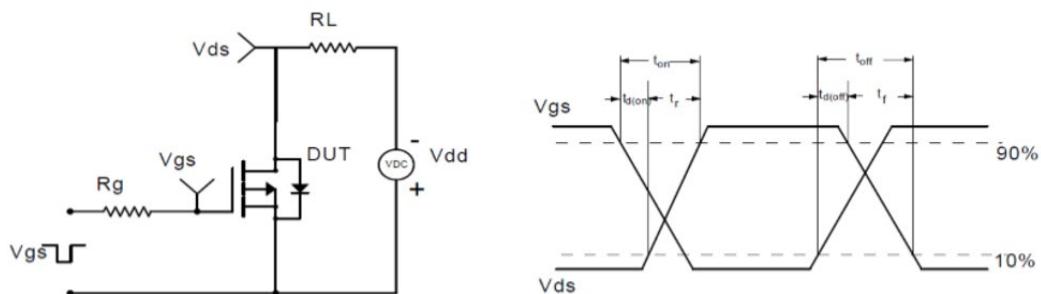
**Figure 12: Peak Current Capacity**



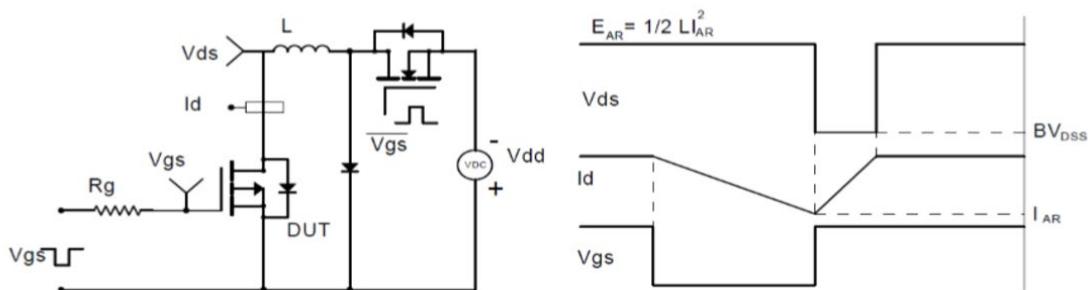
## Test Circuit-P



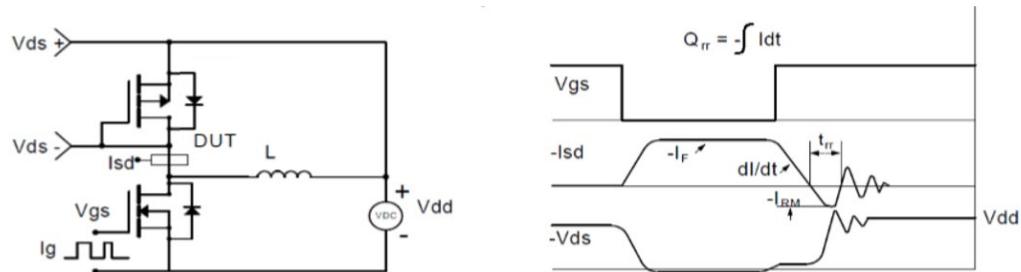
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

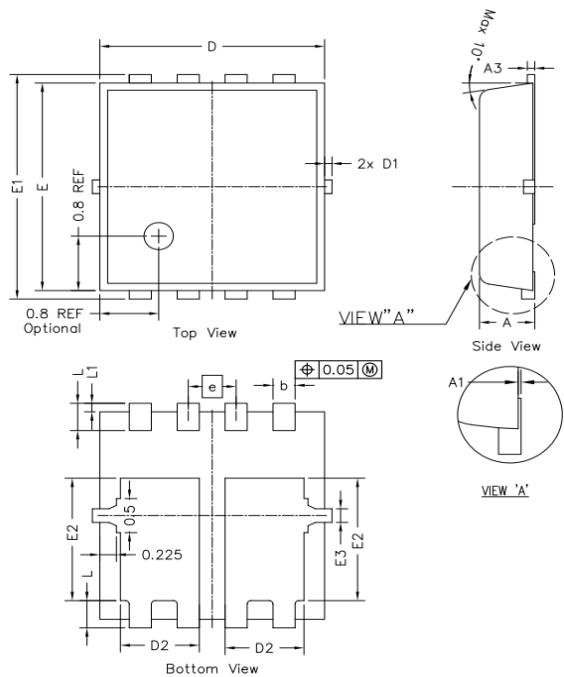


**Figure 3: Unclamped Inductive Switching Test Circuit& Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(PDFN3x3-8L-D)



SYMBOLS	DIMENSION IN MM			DIMENSION IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.700	0.750	0.800	0.028	0.030	0.031
A1	---	---	0.050	----	----	0.002
A3	0.144	0.152	0.202	0.006	0.006	0.008
b	0.250	0.300	0.350	0.010	0.012	0.014
e	0.65 BSC			0.026 BSC		
D	2.950	3.050	3.150	0.116	0.120	0.124
E	2.950	3.050	3.150	0.116	0.120	0.124
D1	---	---	0.125	----	----	0.005
E1	3.200	3.300	3.400	0.126	0.130	0.134
D2	0.970	1.070	1.170	0.038	0.042	0.046
E2	1.700	1.800	1.900	0.067	0.071	0.075
E3	0.150	0.200	0.250	0.006	0.008	0.010
L	0.300	0.400	0.500	0.012	0.016	0.020
L1	0.075	0.125	0.175	0.003	0.005	0.007

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